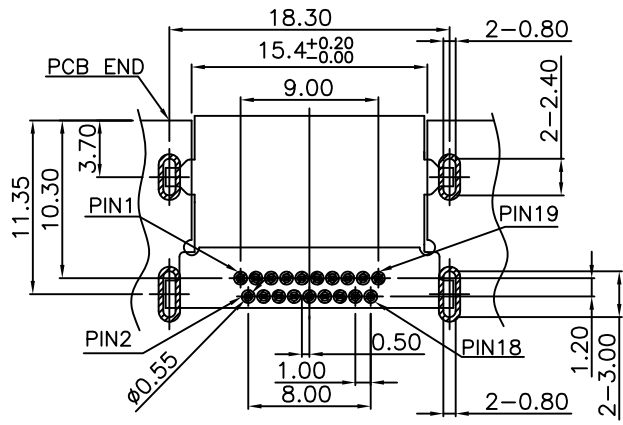
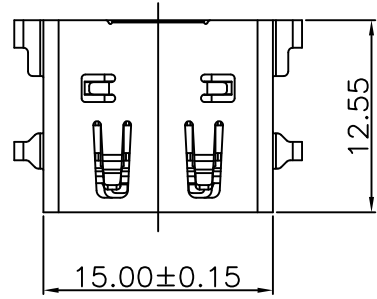
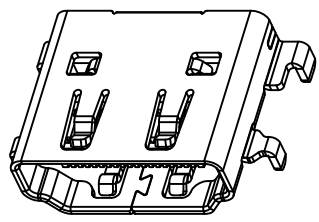
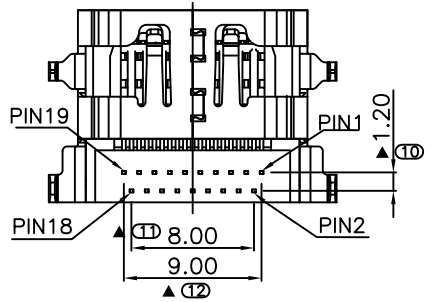
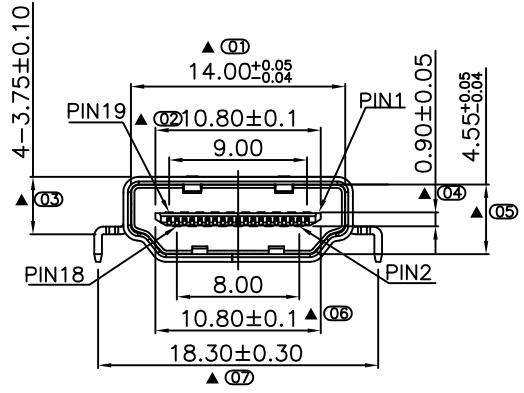
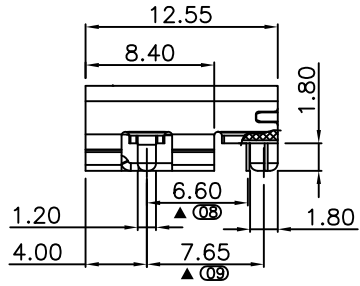


正式图 参考图

Mark	ECN NO.	DESCRIPTION	DESIGN	Date:
—	—	NEW VERSION	Peter Wang	2018.07.19



RECOMMEND PCB LAYOUT  
TOLERANCE: ±0.05  
TOP VIEW



NOTE:  
1.MECHANICAL CHARACTERISTICS  
INSERTION FORCE: 44.1N MAX  
EXTROCTION FORCE: 9.8N MIN, 39.2N MAX  
MATING CYCLE:10000 CYCLES  
2.ELECTRICAL CHARACTERISTICS  
RATING CURRENT: 0.5A  
RATING VOLTAGE: 40V  
CONTACT RESISTANCE: 10 MILLOHMS OHMS MAX (EXCLUDING CONDUCTOR RESISTANCE)  
INSULATION RESISTANCE:  
a, UNMATED: 100M OHMS MIN AT 500 VDC  
b, MATED: 10M OHMS MIN AT 150 VDC  
DIELECTRIC WITHSTANDING VOLTAGE: 300V AC/1MINUTE  
OPERATING TEMPERATURE: -25°C--+85°C  
STORAGE TEMPERATURE: -25°C--+65°C  
Wave Solder 265°C,3~5 Seconds  
IR Reflow, Peak Temp 230~250°C,20~40SEC.  
3.Sign"▲"is importance dimension.

2	C1	LCP 30%.G.F UL94V-0	RoHS2 Fit ( IR Reflow)
1	CO	LCP 30%.G.F UL94V-0	RoHS2&H.F Fit ( IR Reflow)
NO.	CODE	MATERIAL	REMARK

TABLE A : Plactical Material

P/N: HD1128W-XXXX-19XXXXXX

- Model P/N
- Plactical Material (Choose From Table A)
- Housing Color  
□01:Black
- Shell Plating & SALT  
□A:NI PLATING (8H)  
□B:NI PLATING (24H)
- Packing  
□B:Tray; □R:Tape reel;
- Remark  
0:Normal;
- Shell Material  
□C:BRASS.
- Terminal Plating  
□A:CONTACT AREA:GOLD FALSH,SOLDER AREA:MATTE TIN;  
□B:CONTACT AREA:3U"GOLD,SOLDER AREA:MATTE TIN;  
□C:CONTACT AREA:5U"GOLD,SOLDER AREA:MATTE TIN;  
□D:CONTACT AREA:15U"GOLD,SOLDER AREA:MATTE TIN.

3	SHELL	1	SEE P/N.	NICKEL PLATING OVER ALL.	-
2	TERMINAL	19	C2680R-H	Choose from P/N item.	-
1	HOUSING	1	LCP	Choose from P/N item color.	-
NO.	DESCRIPTION	QTY	PARTS MATERIAL	PLATING OR COLOR	REMARK

Tolerance X.X ±0.35 X.XX ±0.25 X.XXX ±0.15 Angle ±3.0°	MODEL NAME:HDMI A/F TYPE MODEL No:HD1128W-XXXX-XXXXXXX	DRAWING: Peter Wang CHECKED: David Zhou APPROVED: Jacky Lee DATE: 2018.07.19
UNIT:mm	SCALE:1:1 REVISION A0 SHEET 1/1	FILE: F/LINGYANG DWG NO. HD1128W-A001

